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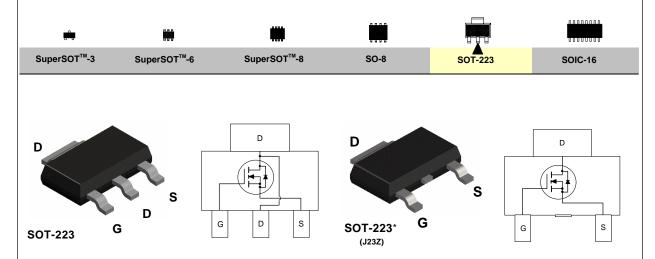
FDT457N N-Channel Enhancement Mode Field Effect Transistor

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance, provide superior switching performance. These products are well suited to low voltage, low current applications such as notebook computer power management, battery powered circuits, and DC motor control.

Features

- High density cell design for extremely low R_{DS(ON)}.
- High power and current handling capability in a widely used surface mount package.



Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

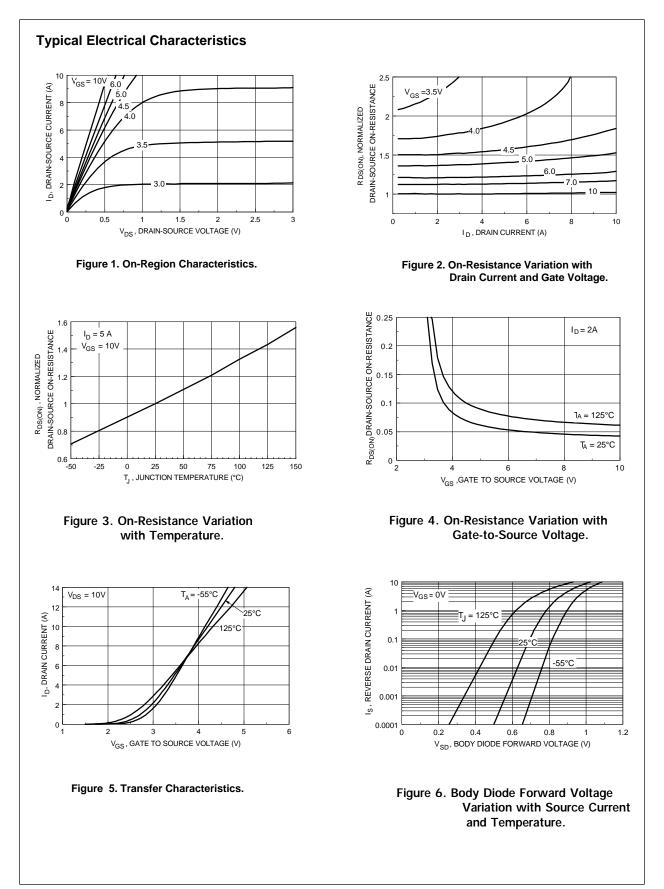
Symbol	Parameter	FDT457N	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage - Continuous	±20	V
I _D	Maximum Drain Current - Continuous (Note 1a)	5	А
	- Pulsed	16	
P _D	Maximum Power Dissipation (Note 1a)	3	W
	(Note 1b)	1.3	
	(Note 1c)	1.1	
「」,T _{stg}	Operating and Storage Temperature Range	-65 to 150	°C
THERMA	L CHARACTERISTICS		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	42	°C/W
۲ _{өлс}	Thermal Resistance, Junction-to-Case (Note 1)	12	°C/W

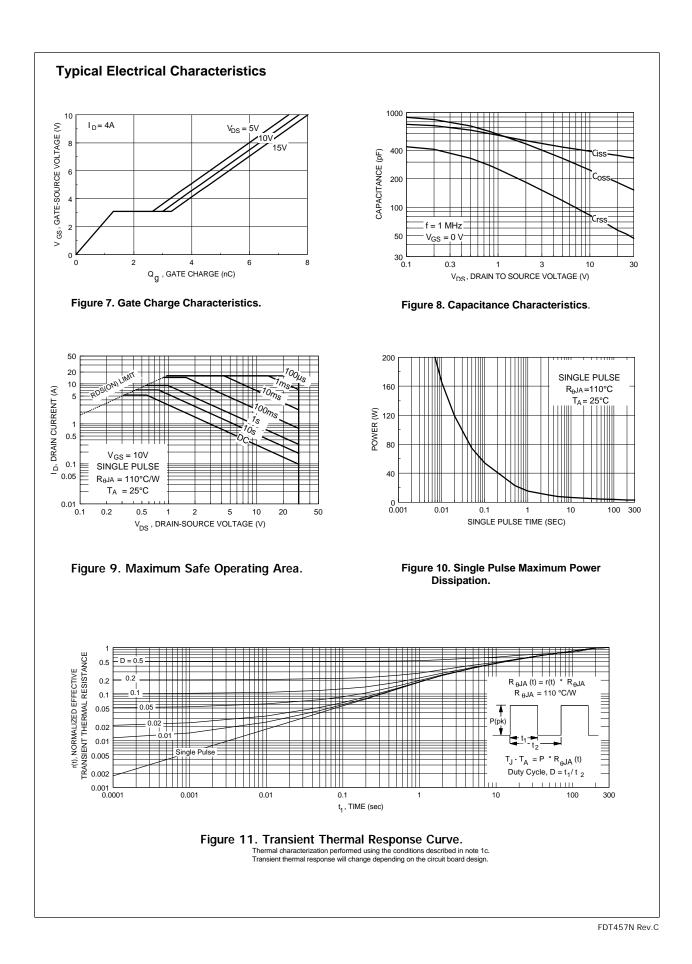
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
3V _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C			35		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				1	μA
033			T_=55°C			10	μA
GSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$, ,			100	nA
GSSR	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note 2)						
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp.Coefficient	$I_{\rm D}$ = 250 µA, Referenced t	o 25 ℃		-4.2		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$			0.043	0.06	Ω
D3(ON)		63 . 5	T_=125°C		0.065	0.1	-
		$V_{GS} = 4.5 \text{ V}, I_{D} = 3.8 \text{ A}$	J		0.071	0.09	
D(ON)	On-State Drain Current	$V_{gs} = 10 \text{ V}, \text{ V}_{ps} = 5 \text{ V}$		5			А
g _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$			5		S
-	HARACTERISTICS	53 / 5					1
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			235		pF
C _{oss}	Output Capacitance				145		pF
C _{rss}	Reverse Transfer Capacitance				50		pF
	CHARACTERISTICS (Note 2)						
D(on)	Turn - On Delay Time	$V_{DD} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			5	10	ns
- () r	Turn - On Rise Time				12	22	ns
D(off)	Turn - Off Delay Time				12	22	ns
- () f	Turn - Off Fall Time				3	8	ns
\mathbf{Q}_{g}	Total Gate Charge	$V_{DS} = 10 \text{ V}, \ \text{I}_{D} = 5 \text{ A},$			4.2	5.9	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$			1.3		nC
 Q _{gd}	Gate-Drain Charge	-			1.7		nC
-	RCE DIODE CHARACTERISTICS AND MAX	IMUM RATINGS					1
Is	Maximum Continuous Drain-Source Diode Fo	rward Current				2.5	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2.5 \text{ A}$ (Note	2)		0.85	1.2	V
-	a. 42°C/W when mounted on a 1 in² pad of 2oz Cu.	b. 95°C/W when mount 0.066 in ² pad of 2oz Cu	ed on a		c. 110°C/W n in² pad of 2c	when mount	bins. R _{euc} is

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%





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